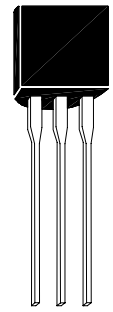
Three Terminal Adjustable Output Positive Voltage Regulators

LM317LA3

The LM317LA3 is an adjustable 3–terminal positive voltage regulator capable of supplying in excess of 100mA over an output voltage range of 1.2 V to 37 V. This voltage regulator is exceptionally easy to use and requires only two external resistors to set the output voltage. Further, it employs internal current limiting, thermal shutdown and safe area compensation, making it essentially blow–out proof.
The LM317LA3 serves a wide variety of applications including local, on-card regulation. This device can also be used to make a programmable output regulator, or by connecting a fixed resistor between the adjustment and output, the LM317LA3 can be used as a precision current regulator.

- Output Current in Excess of 100m A
- Output Adjustable between 1.2 V and 37 V
- Internal Thermal Overload Protection
- Internal Short Circuit Current Limiting Constant with Temperature
- Output Transistor Safe–Area Compensation
- Floating Operation for High Voltage Applications
- Pb-free lead plating and halogen-free package.

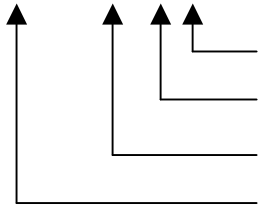
TO-92



A O I

Ordering Information

Device	Package	Shipping
LM317LA3-0-TB-G	TO-92 (Pb-free lead plating and halogen-free package)	2000 pcs / Tape & Box
LM317LA3-0-BK-G	TO-92 (Pb-free lead plating and halogen-free package)	1000 pcs/ bag, 10 bags/box, 10boxes/carton



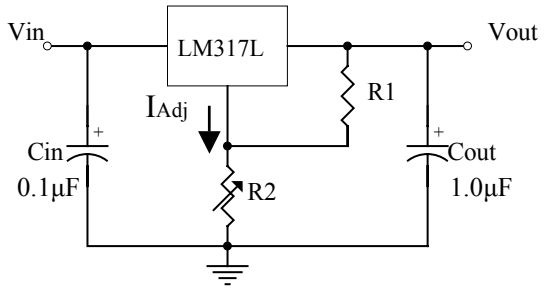
Environment friendly grade : S for RoHS compliant products, G for RoHS compliant and green compound products

Packing spec, TB :2000 pcs/tape & box; BK: 1000 pcs / bag, 10 bags/box, 10 boxes/carton

Product rank, zero for no rank products

Product name

Standard Application



＊Cin is required if regulator is located an appreciate distance from power supply filter.

＊＊Cout is not needed for stability, however, it does improve transient response.

$$V_{out}=1.25(1+R_2/R_1)+I_{Adj}R_2$$

Since I_{Adj} is controlled to less than 100 μA, the error associated with this term is negligible in most applications.

Maximum Ratings T_A=25°C

Rating	Symbol	Value	Unit
Input-Output Voltage Differential	V_I-V_O	40	V
Power Dissipation	P_D	Internally limited	W
Operating Junction Temperature Range	T_J	-40 to +125	℃
Storage Temperature Range	Tstg	-65 to +150	℃

Electrical Characteristics(V_I-V_O=5V,I_O=40mA,T_J=0 to 125℃, P_D≤625mW, unless otherwise noted)

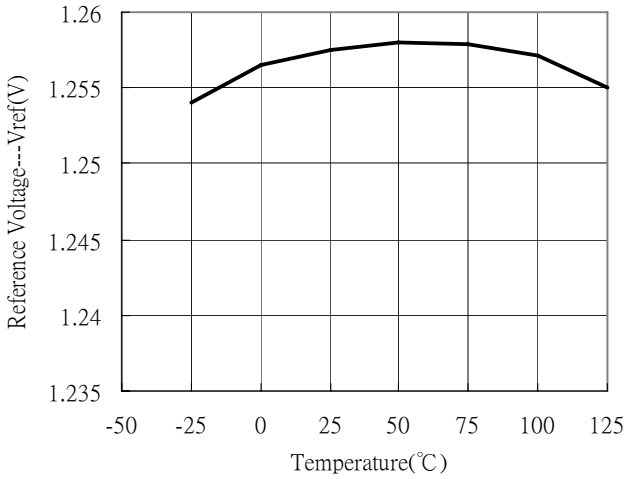
Characteristics	Symbol	Conditions	Min	Typ	Max	Unit
Line Regulation(Note 1)	Reg line	T_A=25℃,3.0V≤V_I-V_O≤40V	-	0.01	0.04	%/V
		3.0V≤V_I-V_O≤40V		0.02	0.07	
Load Regulation(Note 1)	Reg load	T_A=25℃,10mA≤I_O≤100mA				
		V_O≤5.0V	-	5.0	25	mV
		V_O≥5.0V	-	0.1	0.5	%V_O
		10mA≤I_O≤100mA				
		V_O≤5.0V	-	20	70	mV
		V_O≥5.0V	-	0.3	1.5	%V_O
Adjust Pin Current	I_{Adj}		-	50	100	μA
Adjust Pin Current Change	ΔI_{Adj}	3V≤V_I-V_O≤40V,10mA≤I_L≤100mA P_D≤625mW	-	0.2	5.0	μA
Reference Voltage	Vref	3V≤V_I-V_O≤40V,10mA≤I_O≤100mA P_D≤625mW	1.2	1.25	1.3	V
Temperature Stability	Ts	0≤T_J≤125℃	-	0.7	-	%
Minimum Load Current to maintain Regulation	I_{Lmin}	V_I-V_O=40V	-	3.5	10	mA
Maximum Output Current	Imax	V_I-V_O≤15V,P_D≤625mW	100	200	-	mA
		V_I-V_O≤40V,P_D≤625mW, T_A=25℃	25	50	-	
RMS Noise, % of V_O	N	T_A=25℃,10Hz≤f≤10kHz	-	0.003	-	%/V_O
Ripple Rejection(Note 2)	RR	V_O=10V,f=120Hz				dB
		Without C_{Adj}	-	65	-	
		C_{Adj}=10μF	66	80	-	

Long-Term Stability(Note 3)	S	T_J=125℃, 1000Hrs	-	0.3	-	%

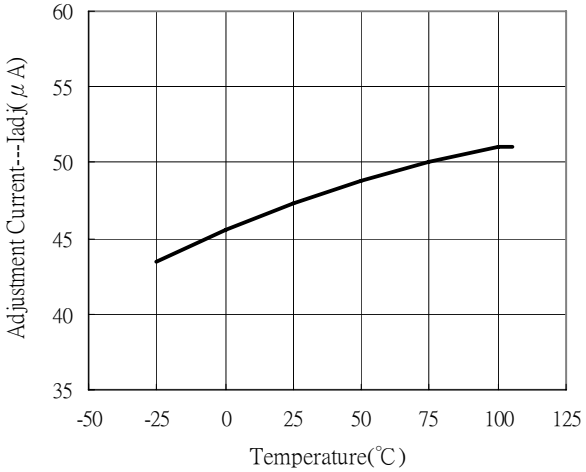
Notes: 1.Load and line regulation are specified at constant junction temperature. Changes in V_O due to heating effects must be taken into account separately. Pulse testing with low duty cycle is used.
2.C_{Adj}, when used, is connected between the adjustment pin and ground.
3.Since long-term stability cannot be measured on each device before shipment, this specification is an engineering estimate of average stability from lot to lot.

Typical Characteristics

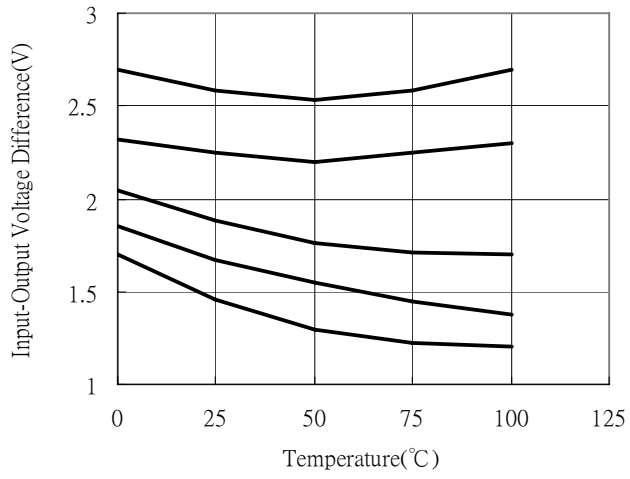
Reference Voltage vs Temperature



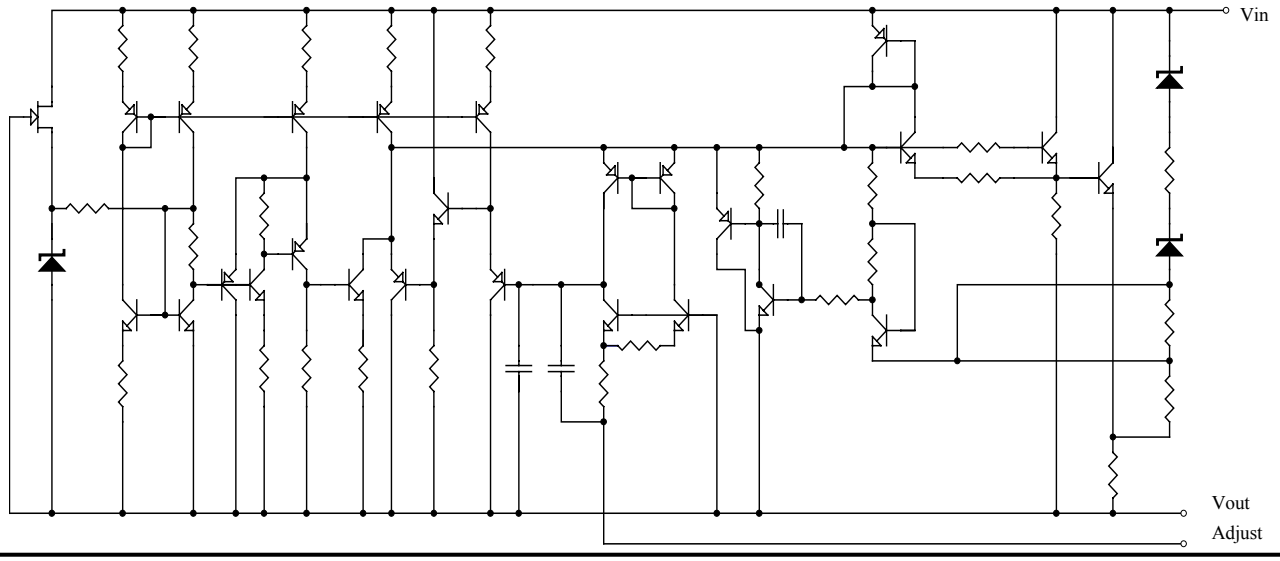
Adjustment Current vs Temperature



Dropout Voltage vs Input-Output Voltage Difference



Representative Schematic Diagram



$$\text{Line Regulation}(\%/V) = \frac{|V_{OH}-V_{OL}|}{|V_{OL}|} \times 100$$

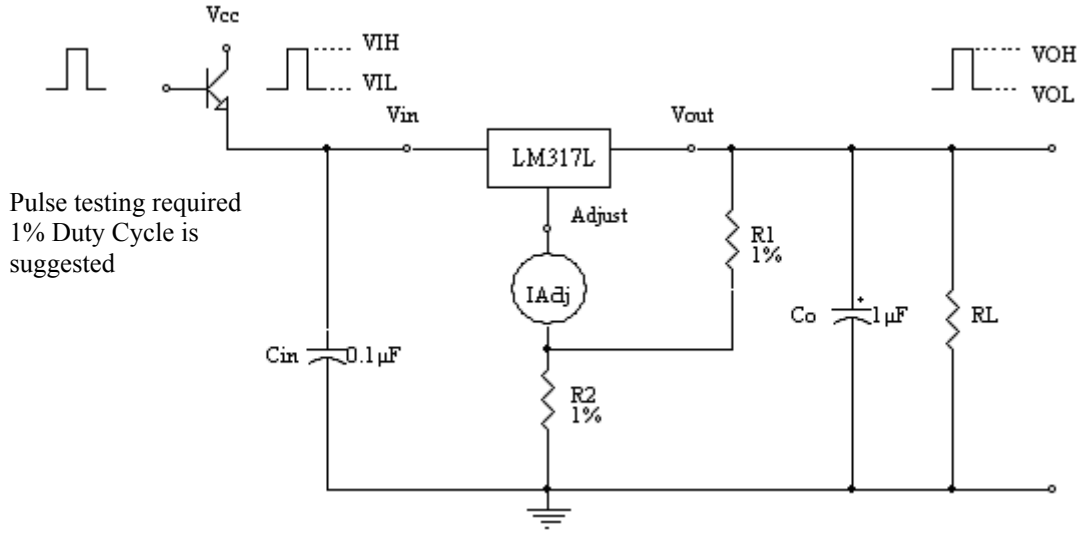
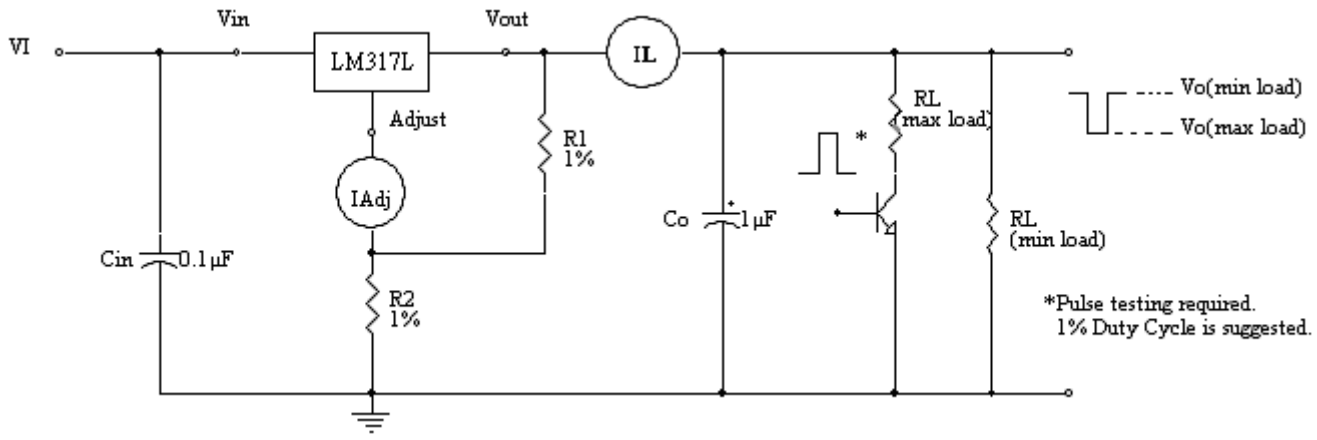


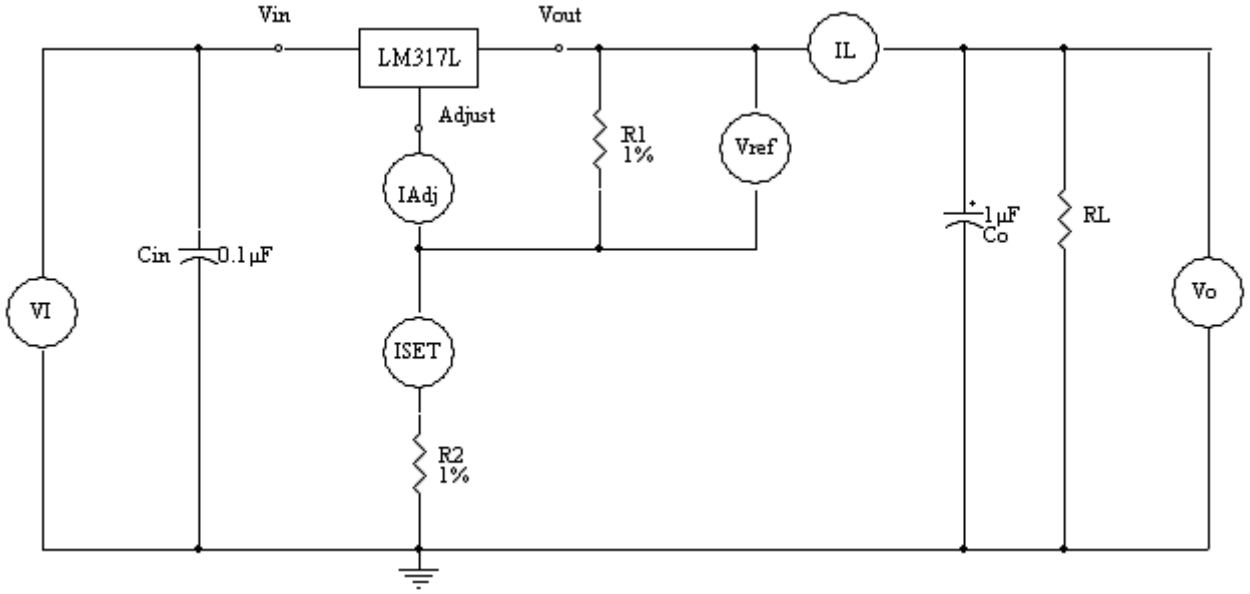
Fig 1. Line Regulation and ΔI_{Adj}/Line test circuit



Load Regulation(mV)=Vo(min load)-Vo(max load)

$$\text{Load Regulation(\%Vo)}=\frac{\text{Vo(min load)-Vo(max load)}}{\text{Vo(min load)}}\times 100$$

Fig 2. Load Regulation and ΔI_{Adj}/Load test circuit



∗ Pulse testing required.
1% Duty Cycle is suggested.

To calculate R2: $V_{out}=I_{SET}R2+1.250V$
Assume I_{SET}=5.25mA

Fig 3. Standard Test Circuit

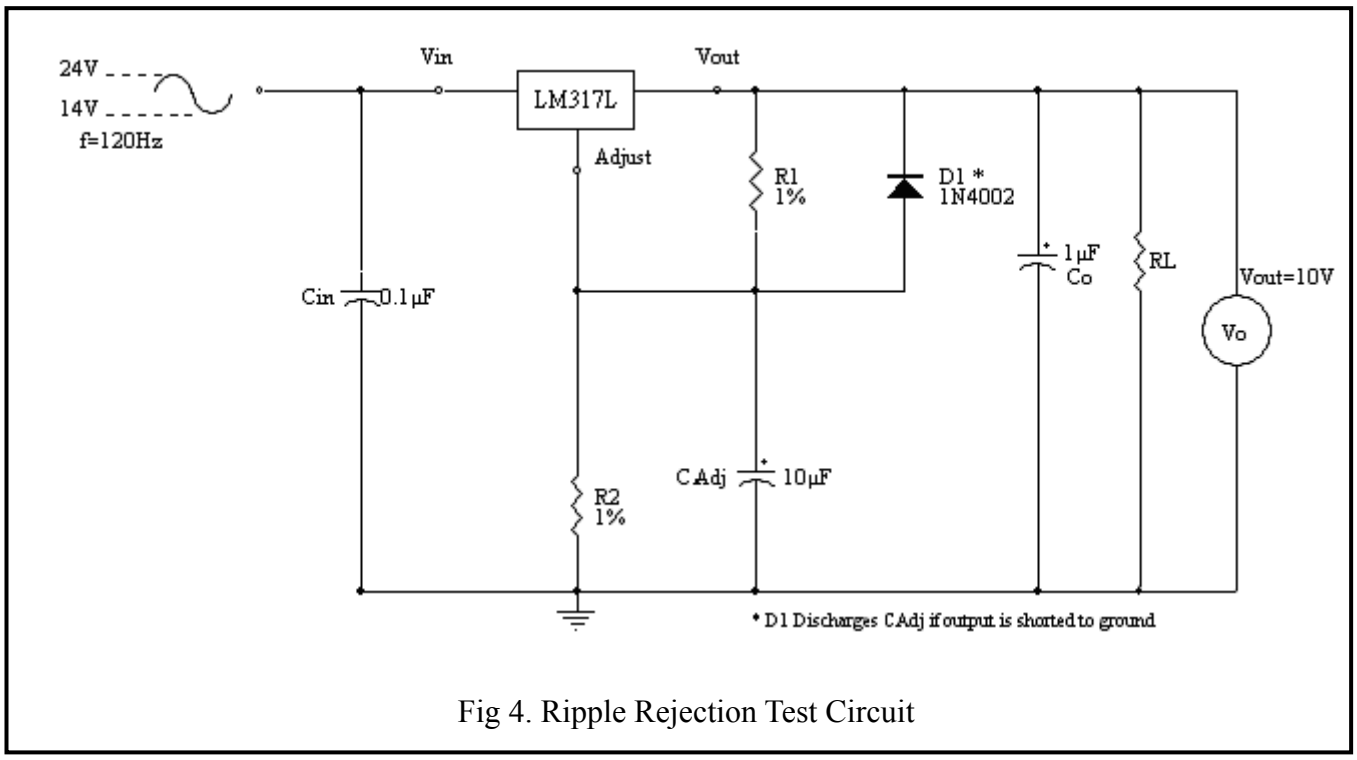


Fig 4. Ripple Rejection Test Circuit

Application Information

Basic Circuit Operation

The LM317L is a 3-terminal floating regulator. In operation, the LM317L develops and maintains a nominal 1.25V reference (Vref) between its output and adjustment terminals. This reference voltage is converted to a programming current (Iprog) by R_1(see Fig 5), and this constant current flows through R_2 to ground. The regulated output voltage is given by:

$$Vout=Vref\left(1+R_2/R_1\right)+I_{Adj}R_2$$

Since the current from the adjustment terminal (I_{Adj}) represents an error term in the equation, the LM317L was designed to control I_{Adj} to less than 100 μA and keep it constant. To do this, all quiescent operating current is returned to the output terminal. This imposes the requirement for a minimum load current. If the load current is less than this minimum, the output voltage will rise.

Since the LM317L is a floating regulator, it is only the voltage differential across the circuit which is important to performance, and operation at high voltages with respect to ground is possible.

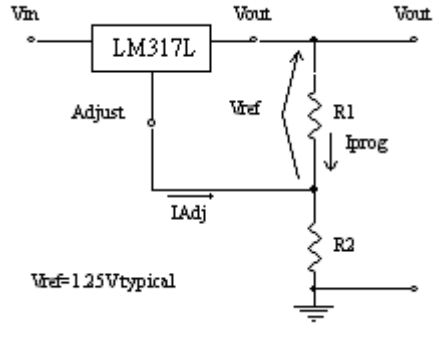


Fig 5. Basic Circuit Configuration

Load Regulation

The LM317L is capable of providing extremely good load regulation, but a few precautions are needed to obtain maximum performance. For best performance, the programming resistor (R_1) should be connected as close to the regulator as possible to minimize line drops which effectively appear in series with the reference, thereby degrading regulation. The ground end of R_2 can be returned near the load ground to provide remote ground sensing and improve load regulation.

External Capacitors

A 0.1μF disc or 1.0μF tantalum input bypass capacitor (Cin) is recommended to reduce the sensitivity to input line impedance.

The adjustment terminal may be bypassed to ground to improve ripple rejection. This capacitor (C_{Adj}) prevents ripple from being amplified as the output voltage is increased. A 10μF capacitor should improve ripple rejection about 15 dB at 120 Hz in a 10V application.

Although the LM317L is stable with no output capacitance, like any feedback circuit, certain values of external capacitance can cause excessive ringing. An output capacitance (Co) in the form of a 1.0μF tantalum or 25μF aluminum electrolytic capacitor on the output swamps this effect and insures stability.

Protection Diodes

When external capacitors are used with any IC regulator, it is sometimes necessary to add protection diodes to prevent the capacitors from discharging through low current points into the regulator.

Fig 6 shows the LM317L with the recommended protection diodes for output voltages in excess of 25V or high capacitance values (Co>25μF,C_{Adj}>10μF). Diode D_1 prevents Co from discharging thru the IC during an input short circuit. Diode D_2 protects against capacitor C_{Adj} discharging through the IC during an output short circuit. The combination of diodes D_1 and D_2 prevents C_{Adj} from discharging through the IC during an input short circuit.

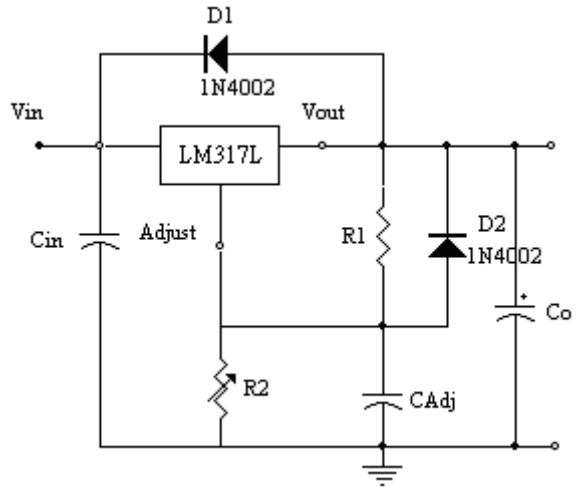


Fig 6. Voltage Regulator with Protection Diodes

Application Circuits

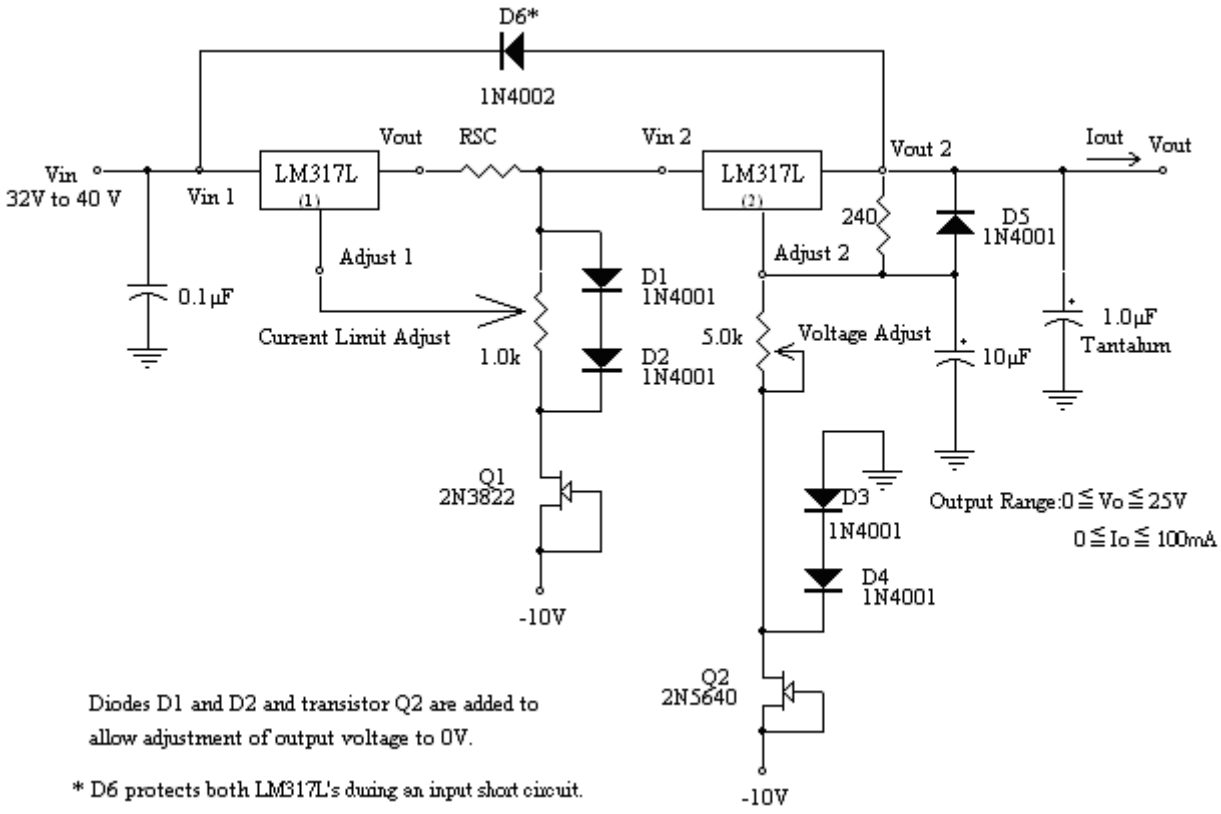


Fig 7. "Laboratory" Power Supply with Adjustable Current Limit and Output Voltage

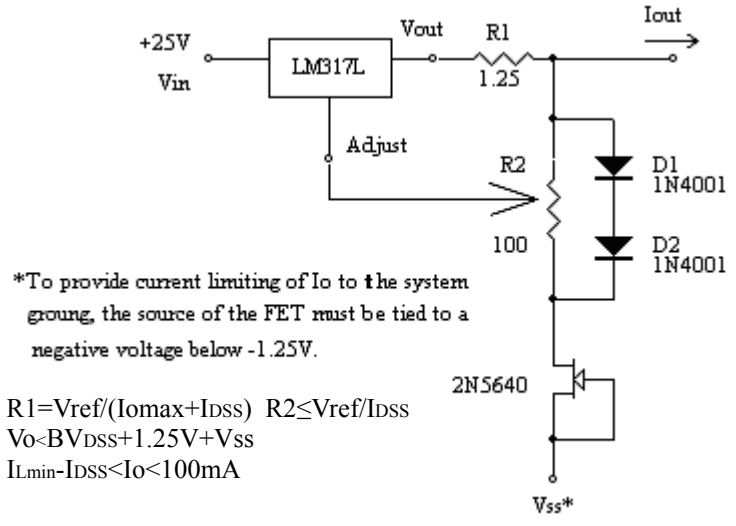


Fig 8. Adjustable Current Limiter

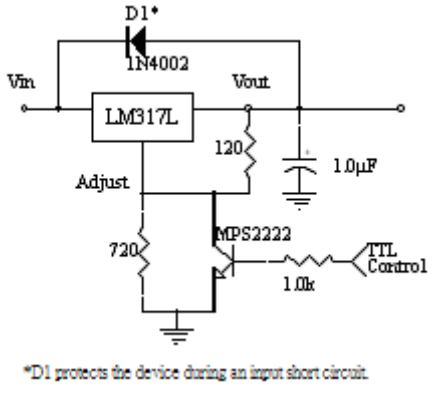


Fig 9. 5.0V Electronic Shutdown Regulator

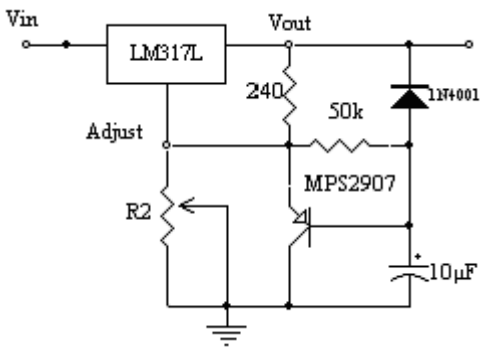


Fig 10. Slow Turn-on Regulator

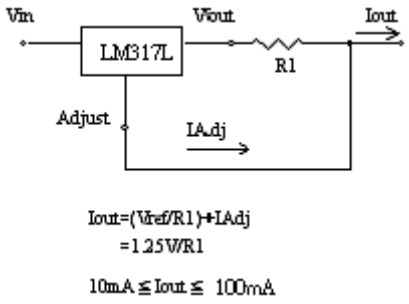
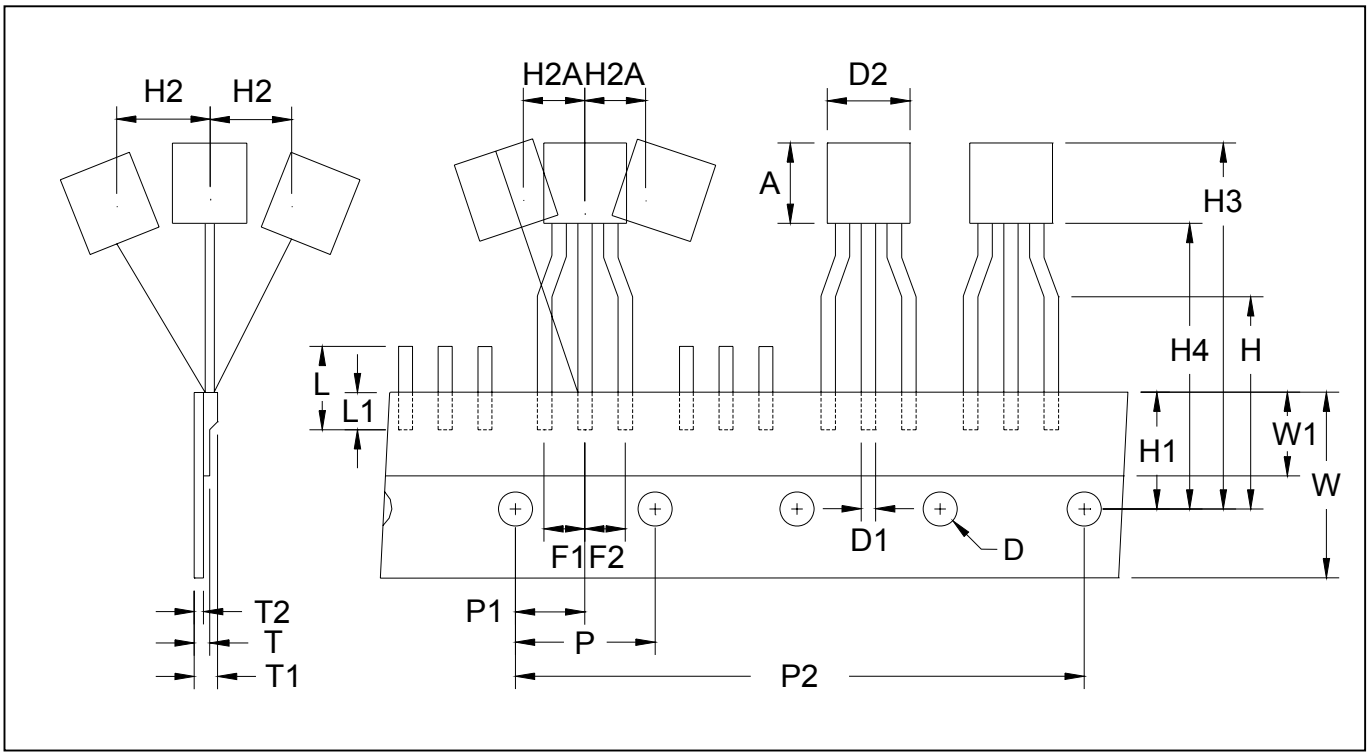


Fig 11. Current Regulator

TO-92 Taping Outline

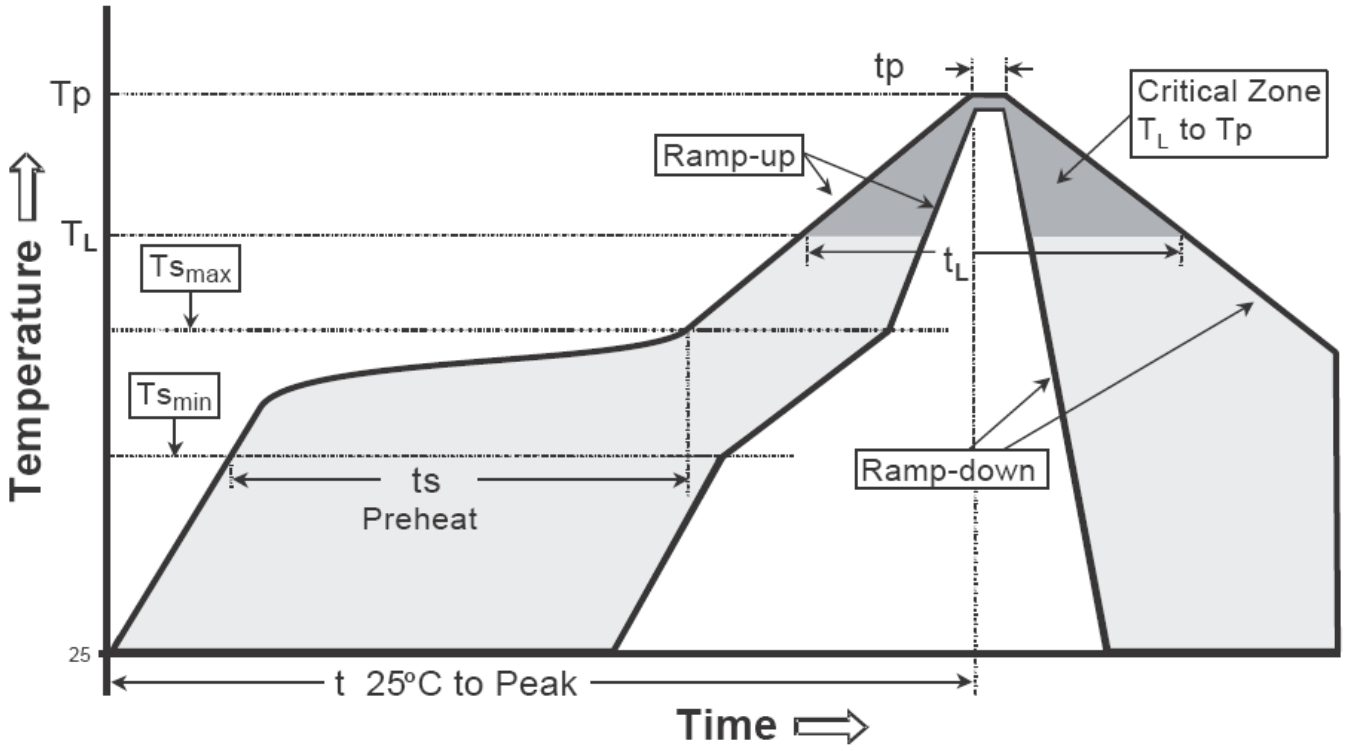


DIM	Item	Millimeters	
		Min.	Max.
A	Component body height	4.33	4.83
D	Tape Feed Diameter	3.80	4.20
D1	Lead Diameter	0.36	0.53
D2	Component Body Diameter	4.33	4.83
F1,F2	Component Lead Pitch	2.40	2.90
F1,F2	F1-F2	-	±0.3
H	Height Of Seating Plane	15.50	16.50
H1	Feed Hole Location	8.50	9.50
H2	Front To Rear Deflection	-	1
H2A	Deflection Left Or Right	-	1
H3	Component Height	-	27
H4	Feed Hole To Bottom Of Component	-	21
L	Lead Length After Component Removal	-	11
L1	Lead Wire Enclosure	2.50	-
P	Feed Hole Pitch	12.50	12.90
P1	Center Of Seating Plane Location	5.95	6.75
P2	4 Feed Hole Pitch	50.30	51.30
T	Over All Tape Thickness	-	0.55
T1	Total Taped Package Thickness	-	1.42
T2	Carrier Tape Thickness	0.36	0.68
W	Tape Width	17.50	19.00
W1	Adhesive Tape Width	5.00	7.00
-	20 pcs Pitch	253	255

Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

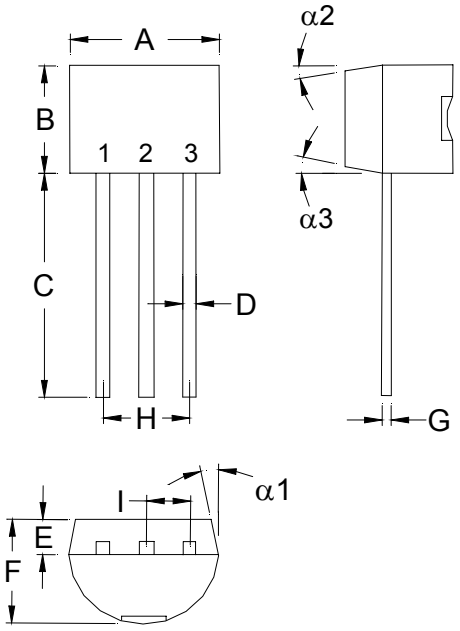
Recommended temperature profile for IR reflow



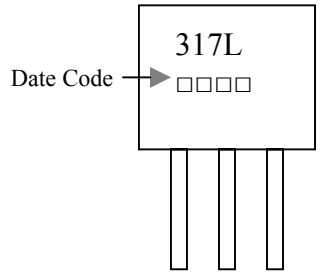
Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmax to Tp)	3°C/second max.	3°C/second max.
Preheat −Temperature Min(Ts min) −Temperature Max(Ts max) −Time(ts min to ts max)	 100°C 150°C 60-120 seconds	 150°C 200°C 60-180 seconds
Time maintained above: −Temperature (TL) − Time (tL)	 183°C 60-150 seconds	 217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

TO-92 Dimension



Marking:



Style: Pin 1.Adj 2.Outpur 3.Input

3-Lead TO-92 Plastic Package
CYStek Package Code: A3

*: Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.1704	0.1902	4.33	4.83	G	0.0142	0.0220	0.36	0.56
B	0.1704	0.1902	4.33	4.83	H	-	*0.1000	-	*2.54
C	0.5000	-	12.70	-	I	-	*0.0500	-	*1.27
D	0.0142	0.0220	0.36	0.56	α1	-	*5°	-	*5°
E	-	*0.0500	-	*1.27	α2	-	*2°	-	*2°
F	0.1323	0.1480	3.36	3.76	α3	-	*2°	-	*2°

Notes: 1.Controlling dimension: millimeters.
2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material.
3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead: Pure tin plated.
- Mold Compound: Epoxy resin family, flammability solid burning class: UL94V-0.

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